

Electronic Supplementary Information (ESI)

A stable polyoxometalate-based porous coordination polymer with highly proton conductivity

Yu-Hui Luo,^{a,b} Li-Qiang Yi,^b Jia-Ni Lu,^a Long-Zhang Dong,^a and Ya-Qian Lan^{*, a}

^a *School of Chemistry and Materials Science, Nanjing Normal University, Jiangsu, Nanjing
210023, P. R. China*

^b *Department of Chemical Engineering, Huaihai Institute of Technology, Jiangsu, Lianyungang
222000, P. R. China*

* Corresponding author. E-mail: yqlan@njnu.edu.cn



Fig. S1 Cu^{II} ions are connected by μ_2 -OH groups to form 1D wave shape Cu-O-Cu chain.

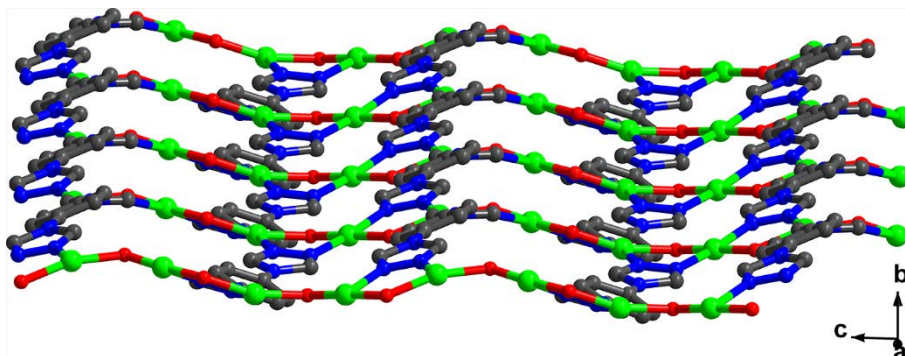


Fig. S2 1D Cu-O-Cu chains are connected by L ligands to generate 2D wavy layer. Coordination water molecules of Cu^{II} ions are omitted for clarify.

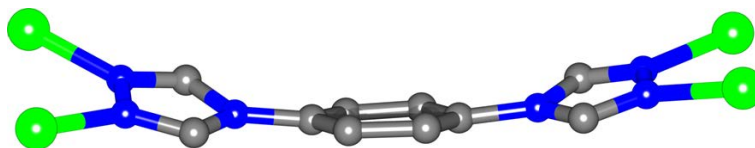


Fig. S3 The L ligands in the framework of **1** are bent into a curved shape.

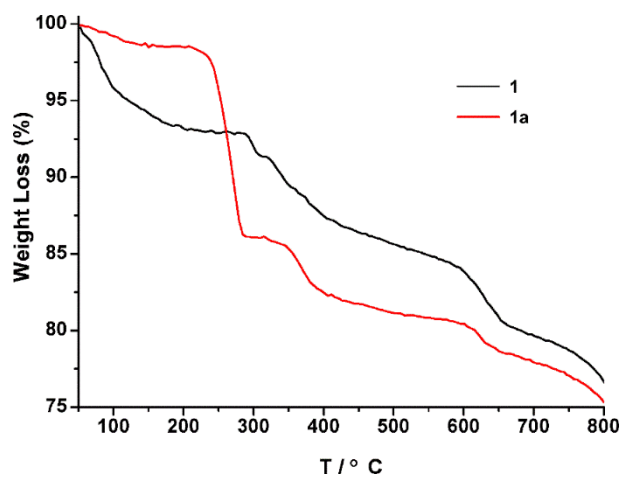


Fig. S5 Thermogravimetric analysis curves of **1** and **1a**.

Elemental analysis of **1a** was performed. Found (%): C, 5.92; H, 1.09; N, 6.05. Thereafter, the loading of N₂H₄·H₂SO₄ was about 5.4 per unit cell. The loaded N₂H₄·H₂SO₄ may presences in both of channels and surface of **1a**. The formula of **1a**

was referred to be $[\text{Cu}_4\text{L}_2(\text{SiW}_{12}\text{O}_{40})(\text{OH})_4]\cdot 4\text{H}_2\text{O}\cdot 2.7\text{N}_2\text{H}_6\text{SO}_4$.

This formula was also confirmed by the TGA datum of **1a**. The TGA curve of **1** reveals only one weight loss of 1.52% (calculated 1.78%) from 50 °C till to 200 °C, causing by the loss of water molecules (Fig. S5). The further weight loss from 210 to 300 °C may be attributed to the decomposition of $\text{N}_2\text{H}_4\cdot\text{H}_2\text{SO}_4$ and the organic component of the framework. To further confirm the formula of **1a**, we have determined the amount of Cu^{2+} with ICP and the amount of SO_4^{2-} with Ion Chromatography, respectively. For Cu, 100 mg of **1a** was heated at 700 °C under air for 4 hours. Thereafter, the residual was dissolved in aqua regia for ICP test. The total amount of Cu was detected to be 12.52 mg. For SO_4^{2-} , 200 mg of **1a** was dissolved in a mixture solution of Na_2EDTA and NaOH , which was diluted before test. The total amount of SO_4^{2-} was detected to be 13.76 mg. The results match well with the formula of **1a**.

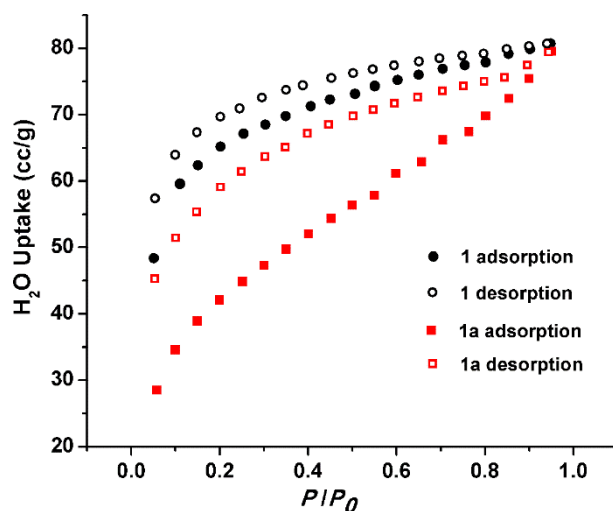


Fig. S6 Water vapor adsorption and desorption isotherms of **1** and **1a**.

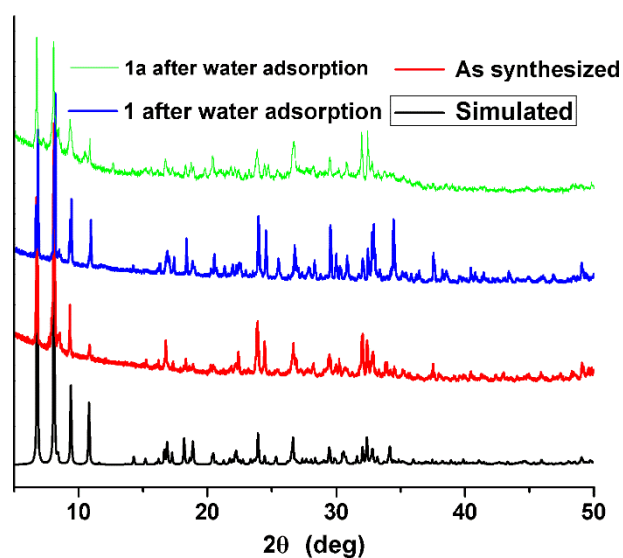


Fig. S7 PXRD patterns for **1** and **1a** after treated under different conditions.

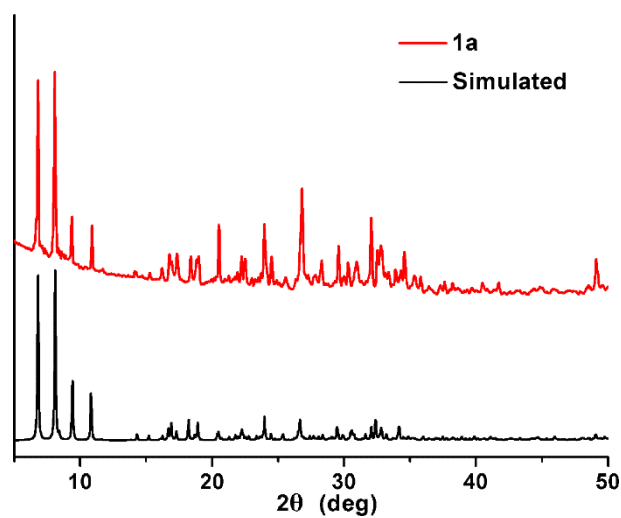


Fig. S8 PXRD patterns of **1a** and simulated **1**.

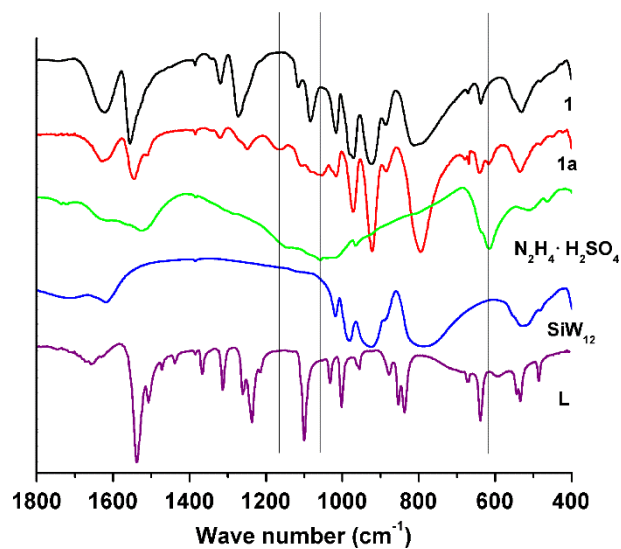


Fig. S9 FT-IR spectrum of **1**, **1a**, $\text{N}_2\text{H}_4 \cdot \text{H}_2\text{SO}_4$, SiW_{12} and **L** ligands. SiW_{12} refers to $\text{H}_4\text{SiW}_{12}\text{O}_{40} \cdot x\text{H}_2\text{O}$.

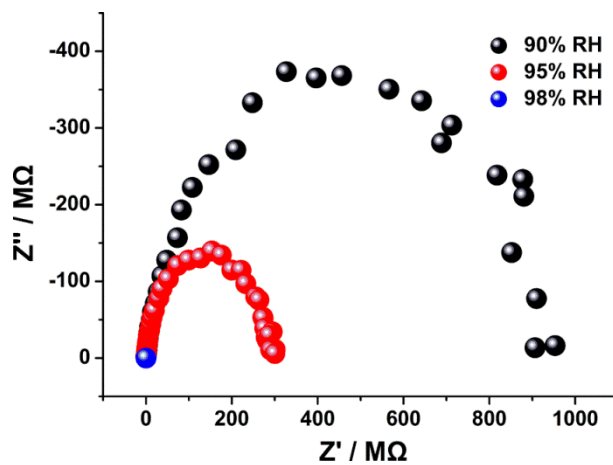


Fig. S10 Impedance spectrum of **1a** at 30 °C with different RHs.

Table S1 Hydrogen-bonding geometry parameters for compound **1**.

D-H $\cdots$ A	Symmetry code	d(D-H) (Å)	d(H $\cdots$ A) (Å)	d(D $\cdots$ A) (Å)	<(DHA) (°)
C1-H1 $\cdots$ O14	<i>x</i> , <i>y</i> , <i>z</i>	0.93	2.26	3.18(4)	168
C2-H2 $\cdots$ O16	<i>x</i> , 1/2- <i>y</i> , 1/2+ <i>z</i>	0.93	2.25	3.16(3)	165
C8-H8 $\cdots$ O20	<i>x</i> , <i>y</i> , 1+ <i>z</i>	0.93	2.42	3.27(4)	153
C9-H9 $\cdots$ O8	1- <i>x</i> , 1- <i>y</i> , 1- <i>z</i>	0.93	2.36	3.29(3)	171

Table S2 Selected bond lengths (Å) and angles (°) of **1**.

Cu1-O23	1.90(2)	Cu1-N5#2	2.06(2)
Cu1-O24	1.92(2)	Cu1-O1W	2.49(4)
Cu1-N1	1.97(3)	Cu1-O2W	2.44(4)
Cu2-O23	1.93(2)	Cu2-N4#1	1.99(2)
Cu2-O24#3	1.94(2)	Cu2-O3W	2.73(6)
Cu2-N2	1.98(2)	Cu2-O4W	2.57(7)
O23-Cu1-O24	176.6(12)	O23-Cu1-N1	89.0(10)
O24-Cu1-N1	93.1(11)	O23-Cu1-N5#2	90.0(9)
O24-Cu1-N5#2	88.1(10)	N1-Cu1-N5#2	174.7(11)
N1-Cu1-O2W	89.4(17)	N5#2-Cu1-O2W	95.9(16)
O23-Cu1-O1W	93.1(15)	O24-Cu1-O1W	89.5(17)
N1-Cu1-O1W	88.4(16)	N5#2-Cu1-O1W	86.4(16)
O2W-Cu1-O1W	174(2)	O24-Cu1-O2W	85.5(19)
O23-Cu1-O2W	91.9(17)		
O23-Cu2-O24#3	163.2(14)	O23-Cu2-N2	88.1(10)
O24#3-Cu2-N2	93.9(11)	O23-Cu2-N4#1	92.3(10)
O24#3-Cu2-N4#1	89.4(11)	N2-Cu2-N4#1	167.1(14)
O23-Cu2-O4W	103.8(19)	O24#2-Cu2-O4W	93(2)
N2-Cu2-O4W	84.4(18)	N4#1-Cu2-O4W	83.0(17)
O23-Cu2-O3W	82.3(15)	O24#2-Cu2-O3W	81.0(17)
N2-Cu2-O3W	103.1(17)	N4#1-Cu2-O3W	89.7(16)
O4W-Cu2-O3W	171(2)		

Symmetry codes: #1, -1+*x*, +*y*, +*z*; #2, -1+*x*, 1/2-*y*, -1/2+*z*; #3, +*x*, 1/2-*y*, 1/2+*z*.

Table S3 The proton conductivities of a part of POM-based polymer.

Compound	Condition (Temp., RH)	Conductivity [S cm ⁻¹]	Ref.
N ₂ H ₆ SO ₄ @[Cu ₄ (C ₁₀ H ₁₀ N ₆) ₂ (SiW ₁₂ O ₄₀)(OH) ₄ (H ₂ O) ₈]·8H ₂ O	338K, 98%	3.9×10 ⁻³	This work
[Cu ₄ (C ₁₀ H ₁₀ N ₆) ₂ (SiW ₁₂ O ₄₀)(OH) ₄ (H ₂ O) ₈]·8H ₂ O	338K, 98%	1.4×10 ⁻⁴	This work
[Sm(H ₂ O) ₅ (CO ₂ CH ₂ NH ₃) ₂][Al(OH) ₆ Mo ₆ O ₁₈]·10H ₂ O	353K, 95%	4.53×10 ⁻³	[1]
H ₃ (3-PyBim) ₂ [PMo ₁₂ O ₄₀]·3.5H ₂ O·CH ₃ CN·CH ₃ OH	373K, 98%	3.34×10 ⁻³	[2]
[Co(bpz)(Hbpz)][Co(SO ₄) _{0.5} (H ₂ O) ₂ (bpz)] ₄ [PMo ^{VI} ₈ Mo ^V ₄ V ^{IV} O ₄₂]·13H ₂ O (NENU-530)	348K, 98%	1.5×10 ⁻³	[3]
[M(H ₂ O) ₈][H(H ₂ O) ₂](HINO) ₄ [PXO ₄₀]M=Zn, Mn, Cu;	373K, 98%	1.3×10 ⁻³	[4]
[P ₂ Mo ₅ O ₂₃][C ₇ H ₇ N ₂] ₆ ·H ₂ O (NNU-6)	323K, 98%	1.21×10 ⁻³	[5]
[H ₃ (3-PyBim) ₂][PMo ₁₂ O ₄₀]·4H ₂ O·CH ₃ CN	373K, 98%	1.36×10 ⁻³	[2]
{H[Ni(HbpdC)(H ₂ O) ₂] ₂ [PW ₁₂ O ₄₀]·8H ₂ O} _n	373K, 98%	1.35×10 ⁻³	[6]
H[Cu(HbpdC)(H ₂ O) ₂] ₂ [PM ₁₂ O ₄₀] M = Mo, W	373K, 98%	10 ⁻⁴ -10 ⁻³	[6]
{[Cu ₃ (L) ₂ (H ₂ O) ₄][Cu(DMF) ₄ (SiW ₁₂ O ₄₀)]·9H ₂ O} _n	373K, 98%	5.97×10 ⁻⁴	[7]
Na ₅ [H ₇ {N(CH ₂ PO ₃) ₃ }Mo ₆ O ₁₆ (OH)(H ₂ O) ₄] ₄	303 K, 98%	7.6×10 ⁻⁴	[8]
[PMo _{11.04} V _{0.96} O ₄₀][C ₃ H ₅ N ₂] ₄ ·H ₂ O (NNU-8)	323K, 98%	4.45×10 ⁻⁴	[5]
{H ₆ [(H ₂ O) _{1.5} (H ₂ biim) ₂ (CH ₃ OH)] ₂ [(H ₂ biim)(CH ₃ OH) ₂]	373 K, 98%	3.1×10 ⁻⁴	[9]
[Ni ₂ (bpz)(Hbpz) ₃ (H ₂ O) ₂][PMo ^{VI} ₈ Mo ^V ₄ V ^{IV} O ₄₄]·8H ₂ O (NENU-531)	358K, 98%	2.8×10 ⁻⁴	[3]
(TMA) ₁₄ H ₂ [Ce ^{III} (H ₂ O) ₆]{[Ce ^{IV} Ce ^{III} O ₆ (OH) ₆ (CO ₃)(H ₂ O) ₁₁][(P ₂ W ₁₆ O ₅₉)] ₃ }·41H ₂ O	373K, 98%	2.65×10 ⁻⁴	[10]
[Zn ₁₂ (trz) ₂₀][SiW ₁₂ O ₄₀]·11H ₂ O	368 K, 95%	1.2×10 ⁻⁴	[11]
[Cu ₁₂ (BTC) ₈ (H ₂ O) ₁₂][H ₃ PW ₁₂ O ₄₀]·nH ₂ O	363K, 70%	4.76×10 ⁻⁵	[12]
[H ₂ EN] ₅ [NiMo ₁₂ O ₃₀ (PO ₄) ₈]·5.5H ₂ O	300K, 98%	2.25×10 ⁻⁵	[13]
[Cu(phen)(H ₂ O)] ₃ [P ₂ Mo ₅ O ₂₃]·5H ₂ O	301 K, 98%	2.2×10 ⁻⁵	[14]
[H ₂ en] ₄ [Ni ₅ (OH) ₃ (trzS) ₃ (en)(H ₂ O)(B-α-PW ₉ O ₃₄)]·6H ₂ O	358K, 98%	1.3×10 ⁻⁵	[15]
[PMo ₁₂ O ₄₀][C ₇ H ₇ N ₂] ₃ ·2H ₂ O (NNU-7)	323K, 98%	6.87×10 ⁻⁶	[5]
[Cu ₃ (μ ₃ -OH)(H ₂ O) ₃ (atz) ₃][P ₂ W ₁₈ O ₆₂]·14H ₂ O	298K, 97%	4.4×10 ⁻⁶	[16]
Cu ₆ (Trz) ₁₀ (H ₂ O) ₄ [H ₂ SiW ₁₂ O ₄₀]·8H ₂ O	368K, 95%	1.84×10 ⁻⁶	[17]

Table S4 Bond valence for Cu ions of compound **1**.

bond	Bond distance	Bond valence	Sum of bond valence
Cu1-O23	1.90	0.647177	Cu1 = 2.27
Cu1-O24	1.92	0.613123	
Cu1-N1	1.97	0.487279	
Cu1-N5	2.06	0.382066	
Cu1-O1W	2.49	0.067485	
Cu1-O2W	2.44	0.073185	
Cu2-O23	1.93	0.596774	Cu2 = 2.18
Cu2-O24	1.94	0.580861	
Cu2-N2	1.98	0.474285	
Cu2-N4	1.99	0.461639	
Cu2-O3W	2.73	0.029187	
Cu2-O4W	2.57	0.041488	

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